Bandpass Filter

EBPF-119-1+

 50Ω 108 to 130 MHz

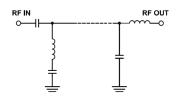
Features

- · Miniature shielded package
- · Low insertion loss
- High rejection

Applications

- Defense/Military
- . Military Radio Communications

Functional Schematic



CASE STYLE: HE1354

Electrical Specifications

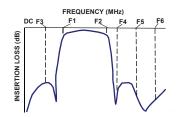
| Parameter | | F# | Frequency (MHz) | Min. | Тур. | Max. | Unit |
|------------------|-------------------------------|----------------|-------------------------|---------|----------|----------|----------|
| | Center Frequency | F1-F2 | _ | _ | 119 | _ | MHz |
| Pass Band | Insertion Loss Return Loss | F1-F2 F1-F2 | 108 - 130 108 - 130 | _ 12 | 2.8 — | 3.5 — | dB dB |
| Stop Band, Lower | Rejection | DC-F3 | DC - 88 | 20 | _ | _ | dB |
| Stop Band, Upper | Rejection | F4-F5 F5-F6 | 150 - 500 500 - 2500 | 17 — | 20 20 | _ _ | dB dB |

| Maximum Ratings | | | | | | |
|-----------------------|---------------|--|--|--|--|--|
| Operating Temperature | -40°C to 85°C | | | | | |
| Storage Temperature | -40°C to 85°C | | | | | |
| RF Power Input | 0.5 W | | | | | |

Permanent damage may occur if any of these limits are exceeded.

Typical Performance Data at 25°C

Typical Frequency Response



+RoHS Compliant

The +Suffix identifies RoHS Compliance. See our web site for RoHS Compliance methodologies and qualifications



A. Performance and quality attributes and conditions not expressly stated in this specification document are intended to be excluded and do not form a part of this specification document.

B. Electrical specifications and performance data contained in this specification document are based on Mini-Circuit's applicable established test performance criteria and measurement instructions.

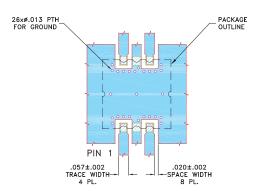
C. The parts covered by this specification document are subject to Mini-Circuits standard limited warranty and terms and conditions (collectively, "Standard Terms"); Purchasers of this part are entitled to the rights and benefits contained therein. For a full statement of the Standard Terms and the exclusive rights and remedies thereunder, please visit Mini-Circuits website at www.minicircuits.com/MCLStore/terms.jsp

Pad Connections

| INPUT | 1 |
|----------|-----|
| OUTPUT | 6 |
| GROUND | 2,5 |
| NOT USED | 3,4 |

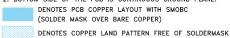
Demo Board MCL P/N: TB-XXXX+ Suggested PCB Layout (PL-680)

SUGGESTED MOUNTING CONFIGURATION FOR HE1354 CASE STYLE

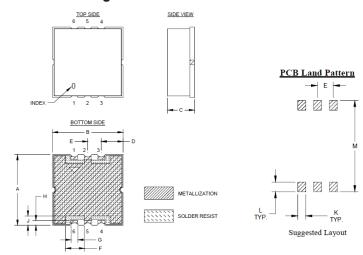


NOTES:

- 1. TRACE WIDTH IS SHOWN FOR ROGERS (RO4350B) WITH DIELECTRIC THICKNESS .030"±.002". COPPER: 1/2 0Z. EACH SIDE.
 FOR OTHER MATERIALS TRACE WIDTH MAY NEED TO BE MODIFIED.
 2. BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.



Outline Drawing



Outline Dimensions (inch)

| Α | В | С | D | Ε | F | G | Н | J | K |
|-------|-------|------|------|------|------|------|------|------|-------|
| .394 | .394 | .150 | .122 | .075 | .098 | .038 | .026 | .051 | .038 |
| 10.01 | 10.01 | 3.81 | 3.10 | 1.90 | 2.49 | 0.97 | 0.66 | 1.29 | 0.97 |
| L | М | | | | | | | | Wt. |
| .046 | .434 | | | | | | | | grams |
| 1.17 | 11.02 | | | | | | | | 0.7 |

Note: Please refer to case style drawing for details

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